

Wire Size AWG

N/A

Electrical

Current - Maximum per Contact

0.5A

Grounding to Panel

N/A

Shielded

No

Voltage - Maximum

30V AC (RMS)/DC

Solder Process Data

Lead-free Process Capability

Reflow Capable (SMT only)

Process Temperature max. C

260

Material Info

Reference - Drawing Numbers

Application Specification

AS-75586-001

Product Specification

PS-75586-001

Sales Drawing

SD-75586-001

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